Adams Super Center for Brain Studies:

TRAVEL FUNDING OPPORTUNITY

January 2024

For the purpose of:

International oversees conferences / Oversees inter-laboratory collaboration / Courses and special workshops abroad for neurosciences graduate students offered by Sagol School of Neuroscience and Adams Super Center for Brain Studies

The Sagol School of Neuroscience and the Adams Super Center for Brain Studies offer scholarships to neurosciences graduate students who wish to actively participate in conferences during the academic year of 2023-2024 (תש"ד), students who have been invited to an overseas laboratory, and students who are travelling abroad for the purpose of participating in courses and workshops. All these activities should be linked to main neuroscience research activity of the labs. The scholarships are granted as travel expense returns (flight, accommodation, registration), according to receipts. The amount of the scholarship will be up to 10,000 NIS for a doctorate candidate and up to 5,000 NIS for a master’s student.
Eligibility:

- Students of advanced degrees who is traveling for one of the purposes described above
- Students whose laboratory is registered with the Sagol School of Neuroscience.
- Each laboratory may submit only one candidate per call. The funding will be open to all students of Sagol School PI’s (including non-Sagol students), but priority will be given to Sagol school students.
- Each student will be able to win a scholarship only once during their degree (PhD and/or master degrees).
- The annual number of scholarships will be approximately 20 (probably divided into two calls), and if the number of applicants will be higher - a selection committee will be established.
- Students must hand in their reimbursement documents during the academic year in which the grant was approved, unless they received a specific approval from the Sagol school administrative staff.
- Applications will be submitted by the students.
- Grant winning students may be invited to Participate (by invitation) university ceremonies to present the student’s research.

See attached grant application forms. Please submit the form and other documents (acceptance letter, PI’s approval etc.) by February 1st 2024 to: hannieharary@tauex.tau.ac.il.

Appendix 1
Application for travel funding opportunity for overseas international conferences.

Please submit a typed form (not handwritten)

Personal details

Name and surname (Hebrew):

Name and surname (English):

Mobile phone:

E-mail:

Program (please circle): master / doctorate

Name of advisor:

Faculty and department:

Research topic:

Name of conference:

Date and location of conference:

Presented as (please circle): oral presentation / poster:

Please attach the following documents:

1. Abstract of the presented work

2. The scientific relationship of the conference to neuroscience

3. Advisor’s/PI’s approval form

4. Confirmation of acceptance to conference program

Date: Signature:
Appendix 2

Application for travel funding opportunity for inter-laboratory collaboration / participation in courses at an overseas academic institution

Please submit a typed form (not handwritten)

Personal details

Name and surname (Hebrew):

Name and surname (English):

Mobile phone:

E-mail:

Program (please circle): master / doctorate

Name of advisor:

Faculty and department:

Research topic:

Course or laboratory name:

Details of the hosting institute (location, name, department, head of laboratory, if relevant):

Length of stay:

Please attach the following documents:

1. Abstract of the relevant research

2. The scientific relationship of the course/collaboration to neuroscience

3. Advisor’s/PI’s approval form

4. Confirmation of acceptance to the program/personalized invitation letter

Date: Signature:
Appendix 3

Advisor/PI’s approval:

(must be filled by Students advisor/PI)

Please submit a typed form (not handwritten)

Full Name:
Department:
Students name:
Reason for application:

I (name) support the application of
my student (name) for the Adams Travel Grant – January 2024.

Date: Signature: